

FDS89161 Dual N-Channel PowerTrench[®] MOSFET 100 V, 2.7 A, 105 m Ω

Features

- Max $r_{DS(on)}$ = 105 m Ω at V_{GS} = 10 V, I_D = 2.7 A
- Max $r_{DS(on)}$ = 171 m Ω at V_{GS} = 6 V, I_D = 2.1 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- 100% UIL Tested
- RoHS Compliant

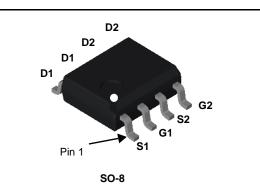


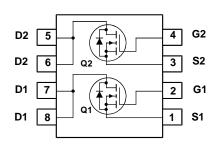
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been optimized for $r_{DS(on)}$, switching performance and ruggedness.

Applications

- Synchronous Rectifier
- Primary Switch For Bridge Topology





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parar	Ratings	Units			
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage	±20	V			
I _D	Drain Current -Continuous			2.7	•	
	-Pulsed		15	Α		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	13	mJ	
P _D	Power Dissipation	T _C = 25 °C		31	w	
	Power Dissipation	(Note1a)	1.6	VV		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	4.0	°C/W
R _{0.JA}	Thermal Resistance, Junction to Ambient	(Note 1a)	78	0/00

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS89161	FDS89161	SO-8	13 "	12 mm	2500 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V	
ΔΒV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		67		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$	2	3	4	V	
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-9		mV/°C	
	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 2.7 A		86	105		
r _{DS(on)}		V _{GS} = 6 V, I _D = 2.1 A		120	171		
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.7 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		144	176		
9fs	Forward Transconductance	$V_{DS} = 10 \text{ V}, I_D = 2.7 \text{ A}$		5		S	
Dynamic	Characteristics						
C _{iss}	Input Capacitance			158	210	pF	
C _{oss}	Output Capacitance	──V _{DS} = 50 V, V _{GS} = 0 V, ──f = 1MHz		43	58	pF	
C _{rss}	Reverse Transfer Capacitance			3	5	pF	
R _g	Gate Resistance			1		Ω	
Switching	Characteristics						
t _{d(on)}	Turn-On Delay Time			4.2	10	ns	
t _r	Rise Time	V _{DD} = 50 V, I _D = 2.7 A,		1.3	10	ns	
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		7.3	15	ns	
t _f	Fall Time			1.9	10	ns	
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		3	4.1	nC	
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 \text{ V to 5 V}$ $V_{DD} = 50 \text{ V},$		1.7	2.4		
Q _{gs}	Gate to Source Charge	I _D = 2.7 A		0.8		nC	
	Gate to Drain "Miller" Charge			0.8	1	nC	

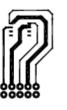
V _{SD} S	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 2.7 A$	(Note 2)	0.85	1.3	V
	Source to Drain Diode Porward Voltage	$V_{GS} = 0 V, I_{S} = 2 A$	(Note 2)	0.82	1.2	
t _{rr}	Reverse Recovery Time	I _F = 2.7 A, di/dt = 100 A/μs		34	54	ns
Q _{rr}	Reverse Recovery Charge			21	34	nC

NOTES:

1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.

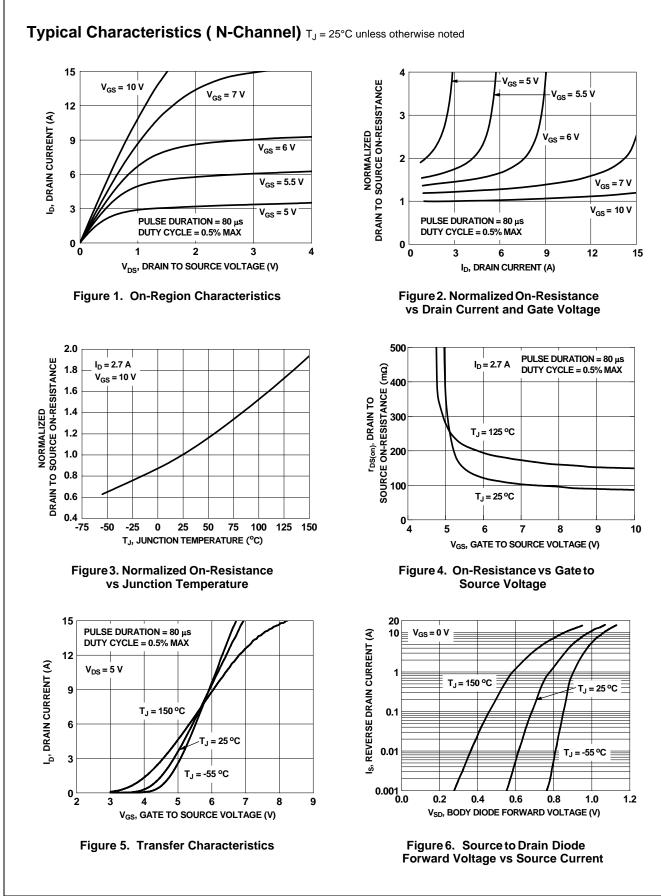


a) 78°C/W when mounted on a 1 in² pad of 2 oz copper



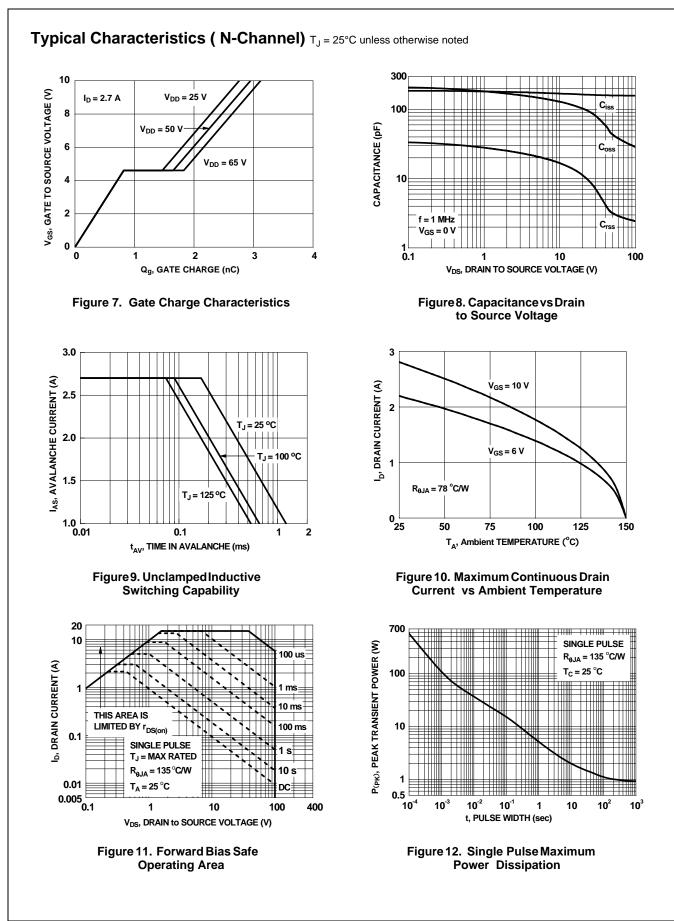
b) 135°C/W when mounted on a minimun pad

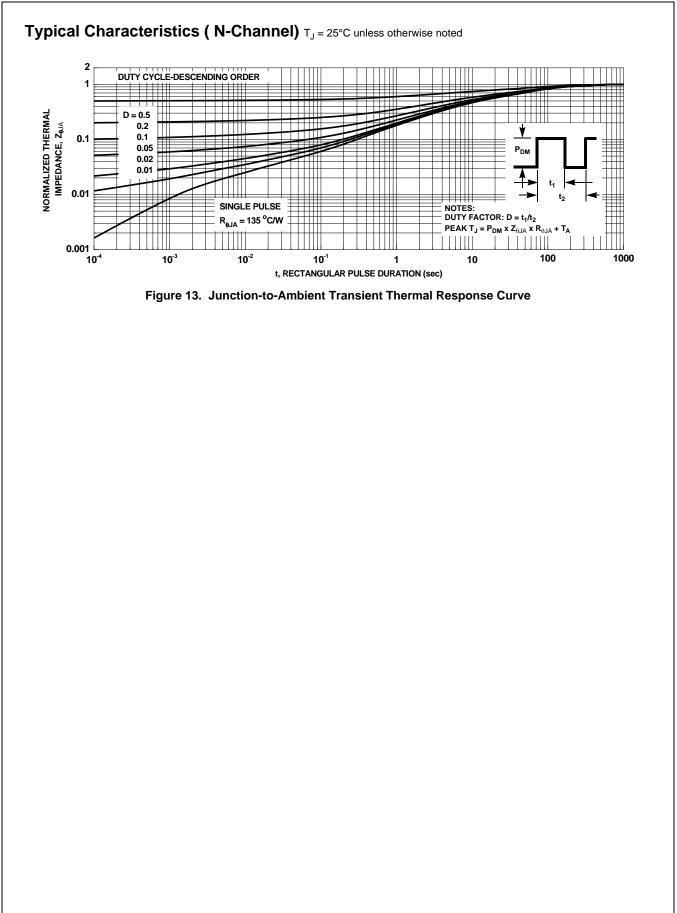
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%. 3. Starting T_J = 25°C, L = 3 mH, I_{AS} = 3 A, V_DD = 100 V, V_{GS} = 10 V.

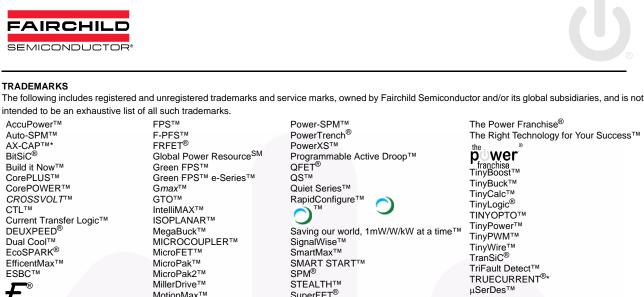


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